

KS54AHCT 194
KS74AHCT

4-Bit Bidirectional
Universal Shift Registers

T-46-09-05

FEATURES

- Parallel-to-Serial, Serial-to-Parallel Conversions
- Left or Right Shifts
- Parallel Synchronous Loading
- Direct Overriding Clear
- Temporary Data Latching Capability
- Function, pin-out, speed and drive compatibility with 54/74ALS logic family
- Low power consumption characteristic of CMOS
- High-Drive-Current outputs:
I_{OL} = 8 mA @ V_{OL} = 0.5V
- Inputs and outputs interface directly with TTL, NMOS and CMOS devices
- Wide operating voltage range: 4.5V to 5.5V
- Characterized for operation over industrial and military temperature ranges:
KS74AHCT: -40°C to +85°C
KS54AHCT: -55°C to +125°C
- Package options include plastic "small outline" packages, standard plastic and ceramic 300-mil DIPs

DESCRIPTION

These bidirectional shift registers feature parallel outputs, right-shift and left-shift serial inputs, operating-mode-control inputs, and a direct overriding clear line. The register has four distinct modes of operation:

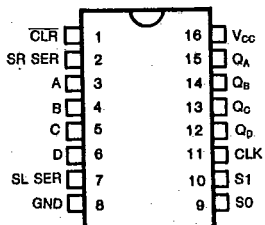
- Inhibit clock (temporary data latch/do nothing)
- Shift-right (in the direction Q_A toward Q_D)
- Shift-left (in the direction Q_D toward Q_A)
- Parallel (broadside) load

Synchronous parallel loading is accomplished by applying the four bits of data and taking both mode control inputs, S0 and S1, high. The data is loaded into the associated flip-flops and appear at the outputs after the positive transition of the clock input. During loading, serial data flow is inhibited.

Shift-right is accomplished synchronously with the rising edge of the clock pulse when S0 is high and S1 is low. Serial data for this mode is entered at the shift-right data input. When S0 is low and S1 is high, data shifts left synchronously and new data is entered at the shift-left serial inputs. Clocking of the flip-flop is inhibited when both mode control inputs are low.

4

PIN CONFIGURATION



FUNCTION TABLE

CLR	INPUTS				OUTPUTS							
	MODE		CLK	SERIAL		PARALLEL						
	S1	S0		LEFT	RIGHT	A	B	C	D			
L	X	X	X	X	X	X	X	X	L	L	L	L
H	X	X	L	X	X	X	X	X	Q _{A0}	Q _{B0}	Q _{C0}	Q _{D0}
H	H	H	↑	X	X	a	b	c	a	b	c	d
H	L	H	↑	X	H	X	X	X	H	Q _{An}	Q _{Bn}	Q _{Cn}
H	L	H	↑	X	L	X	X	X	L	Q _{An}	Q _{Bn}	Q _{Cn}
H	H	L	↑	H	X	X	X	X	Q _{Bn}	Q _{Cn}	Q _{Dn}	H
H	H	L	↑	L	X	X	X	X	Q _{Bn}	Q _{Cn}	Q _{Dn}	L
H	L	L	X	X	X	X	X	X	Q _{A0}	Q _{B0}	Q _{C0}	Q _{D0}

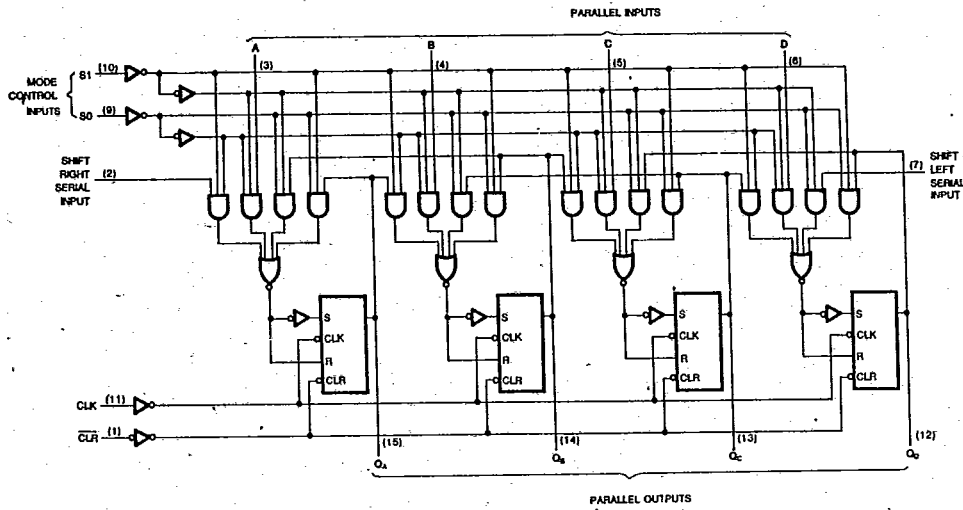
H=high level (steady state)
L=low level (steady state)
X=irrelevant (any input, including transitions)
↑=transition from low to high level
a,b,c,d=the level of steady-state input at inputs A,B,C, or D, respectively.
Q_{A0}, Q_{B0}, Q_{C0}, Q_{D0}=the level of Q_A, Q_B, Q_C, or Q_D, respectively, before the indicated steady-state input conditions were established.
Q_{An}, Q_{Bn}, Q_{Cn}, Q_{Dn}=the level of Q_A, Q_B, Q_C, respectively, before the most-recent ↑ transition of the clock.

KS54AHCT 194
KS74AHCT

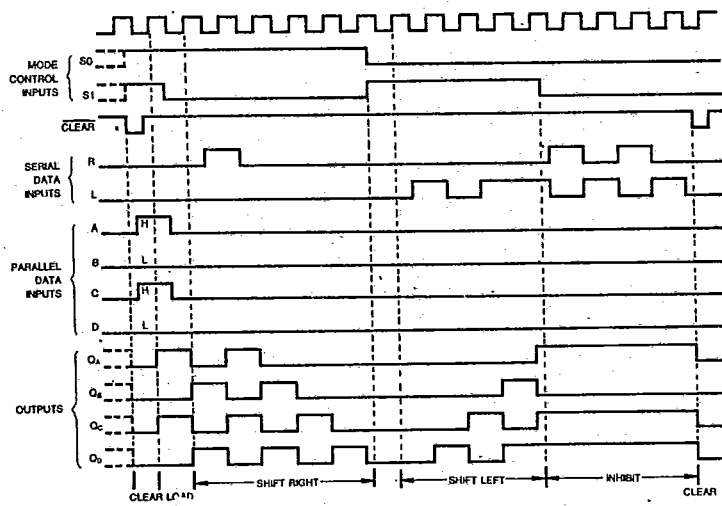
4-Bit Bidirectional
Universal Shift Registers

T-46-09-05

LOGIC DIAGRAM



typical clear, load, right-shift, inhibit, and clear sequences



KS54AHCT 194
KS74AHCT

4-Bit Bidirectional
Universal Shift Registers

T-46-09-05

Absolute Maximum Ratings*

Supply Voltage Range V_{CC} -0.5V to +7V
 DC Input Diode Current, I_{IK}
 ($V_I < -0.5V$ or $V_I > V_{CC} + 0.5V$) ± 20 mA
 DC Output Diode Current, I_{OK}
 ($V_O < -0.5V$ or $V_O > V_{CC} + 0.5V$) ± 20 mA
 Continuous Output Current Per Pin, I_O
 ($-0.5V < V_O < V_{CC} + 0.5V$) ± 35 mA
 Continuous Current Through
 V_{CC} or GND pins ± 125 mA
 Storage Temperature Range, T_{stg} -65°C to +150°C
 Power Dissipation Per Package, P_d † 500 mW

* Absolute Maximum Ratings are those values beyond which permanent damage to the device may occur. These are stress ratings only and functional operation of the device at or beyond them is not implied. Long exposure to these conditions may affect device reliability.

† Power Dissipation temperature derating:
 Plastic Package (N): -12mW/°C from 65°C to 85°C
 Ceramic Package (J): -12mW/°C from 100°C to 125°C

Recommended Operating Conditions

Supply Voltage, V_{CC} 4.5V to 5.5V
 DC Input & Output Voltages*, V_{IN} , V_{OUT} 0V to V_{CC}
 Operating Temperature
 Range KS74AHCT: -40°C to +85°C
 KS54AHCT: -55°C to +125°C
 Input Rise & Fall Times, t_r , t_f Max 500 ns
 * Unused inputs must always be tied to an appropriate logic voltage level (either V_{CC} or GND)

DC ELECTRICAL CHARACTERISTICS ($V_{CC}=5V \pm 10\%$ Unless Otherwise Specified)

Characteristic	Symbol	Test Conditions	$T_a = 25^\circ C$		KS74AHCT $T_a = -40^\circ C$ to $+85^\circ C$		KS54AHCT $T_a = -55^\circ C$ to $+125^\circ C$		Unit
			Typ	Guaranteed Limits	Typ	Guaranteed Limits	Typ	Guaranteed Limits	
Minimum High-Level Input Voltage	V_{IH}			2.0	2.0	2.0			V
Maximum Low-Level Input Voltage	V_{IL}			0.8	0.8	0.8			V
Minimum High-Level Output Voltage	V_{OH}	$V_{IN}=V_{IH}$ or V_{IL} $I_O = -20\mu A$ $I_O = -4mA$	V_{CC} 4.2	$V_{CC} - 0.1$ 3.98	$V_{CC} - 0.1$ 3.84	$V_{CC} - 0.1$ 3.7			V
Maximum Low-Level Output Voltage	V_{OL}	$V_{IN}=V_{IH}$ or V_{IL} $I_O = 20\mu A$ $I_O = 4mA$ $I_O = 8mA$	0	0.1 0.26 0.39	0.1 0.33 0.5	0.1 0.4			V
Maximum Input Current	I_{IN}	$V_{IN}=V_{CC}$ or GND		± 0.1	± 1.0	± 1.0			μA
Maximum Quiescent Supply Current	I_{CC}	$V_{IN}=V_{CC}$ or GND $I_{OUT}=0\mu A$		8.0	80.0	160.0			μA
Additional Worst Case Supply Current	ΔI_{CC}	per input pin $V_I = 2.4V$ other inputs: at V_{CC} or GND $I_{OUT}=0\mu A$		2.7	2.9	3.0			mA

KS54AHCT 194
KS74AHCT
4-Bit Bidirectional
Universal Shift Registers

T-46-09-05

AC ELECTRICAL CHARACTERISTICS (Input $t_r, t_f \leq 2$ ns), AHCT194

Characteristic	Symbol	Conditions†	$T_a = 25^\circ\text{C}$	KS74AHCT		KS54AHCT		Unit
			$V_{CC} = 5.0\text{V}$	$T_a = -40^\circ\text{C to } +85^\circ\text{C}$ $V_{CC} = 5.0\text{V} \pm 10\%$		$T_a = -55^\circ\text{C to } +125^\circ\text{C}$ $V_{CC} = 5.0\text{V} \pm 10\%$		
			Typ	Min	Max	Min	Max	
Maximum Clock Frequency	f_{max}	$C_L = 50\text{pF}$	60	35		30		MHz
Propagation Delay, CLK to Q_H	t_{PLH}		10		17		20	ns
	t_{PHL}		10		17		20	ns
Propagation Delay, CLR to Q_H	t_{PHL}		11		19		22	ns
Pulse Width	CLR LOW		10	17		20		ns
	CLK High or LOW		t_w	10	17		20	ns
Setup Time, Any Input before CLK†	t_s		10	17		20		ns
Hold Time, Data after CLK†	t_h		-3	0		0		ns
Input Capacitance	C_{IN}		5					pF
Power Dissipation Capacitance*	C_{PD}		80					pF

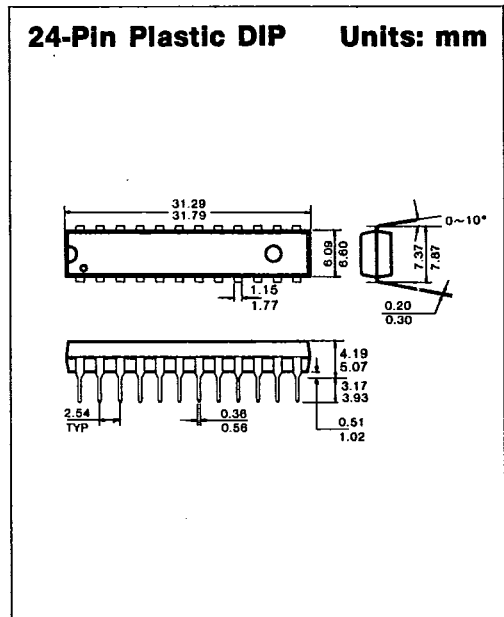
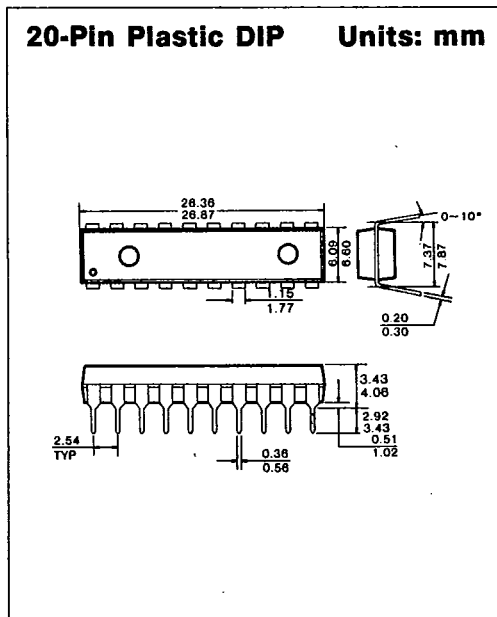
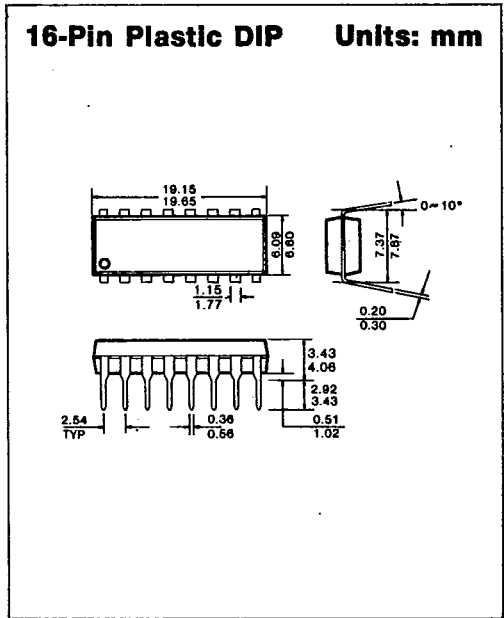
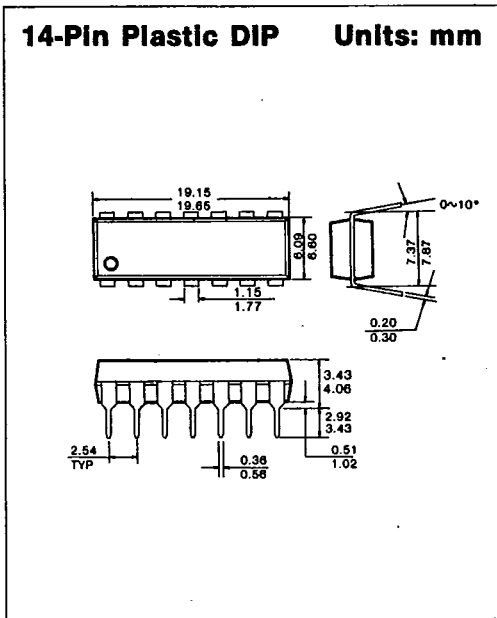
* C_{PD} determines the no-load dynamic power dissipation: $P_D = C_{PD} V_{CC}^2 f + I_{CC} V_{CC}$.

† For AC switching test circuits and timing waveforms see section 2.

PACKAGE DIMENSIONS

T-90-20

1. PLASTIC PACKAGES



7



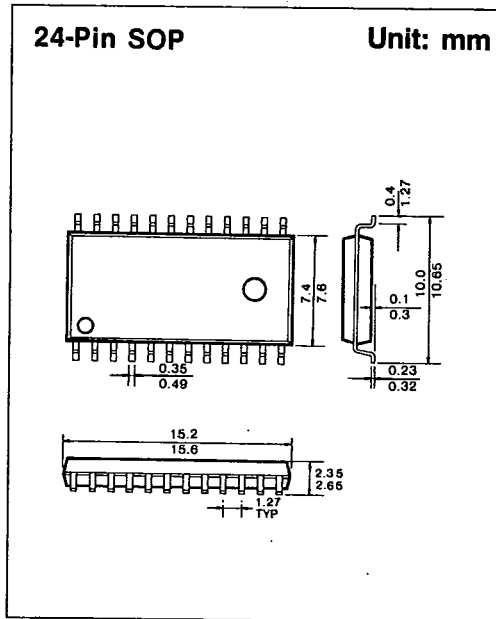
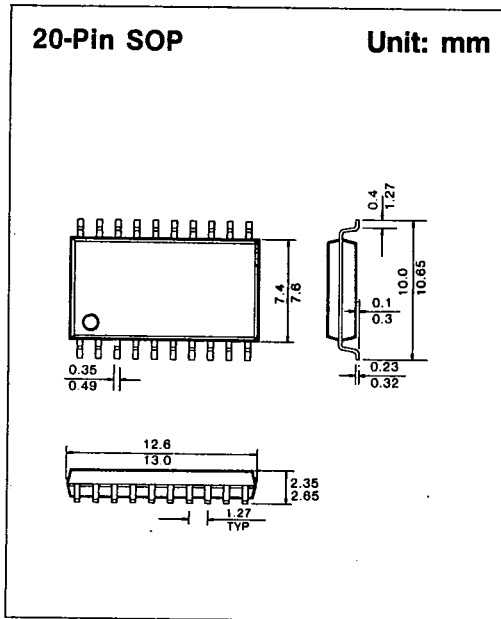
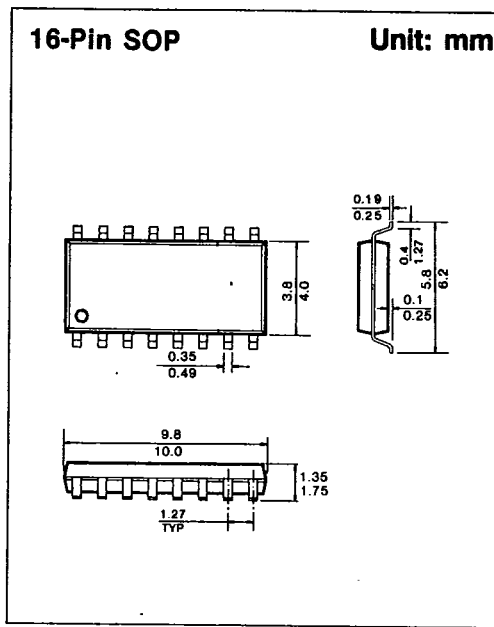
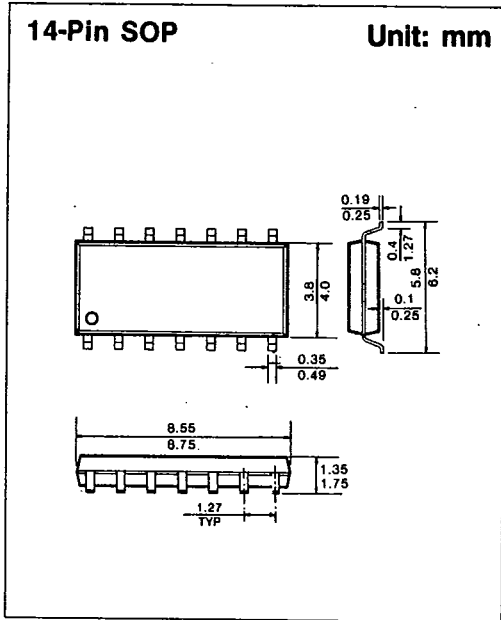
SAMSUNG SEMICONDUCTOR

1675

A-04

PACKAGE DIMENSIONS

T-90-20

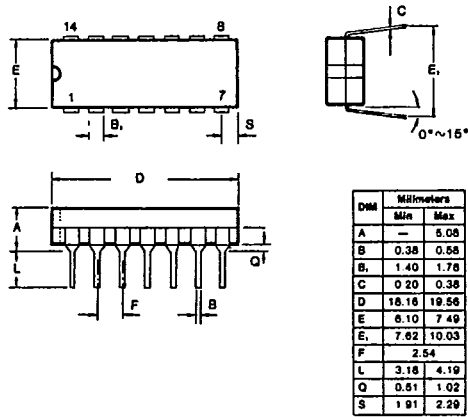


PACKAGE DIMENSIONS

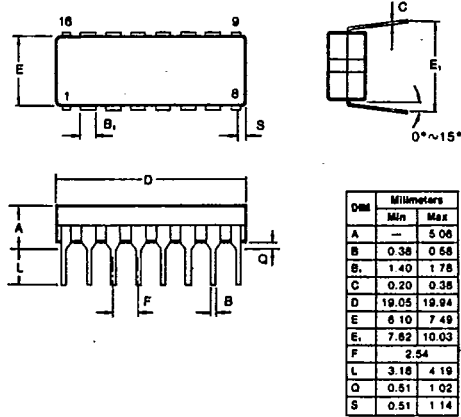
T-90-20

2. CERAMIC PACKAGES

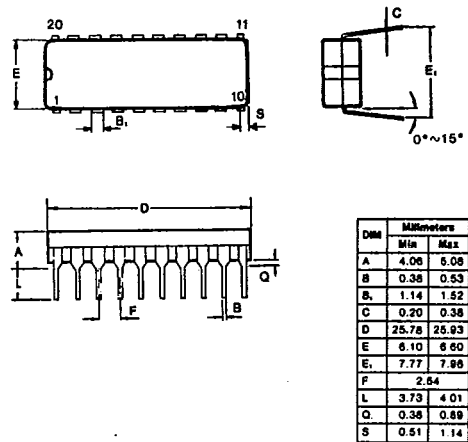
14-Pin Ceramic DIP Units: mm



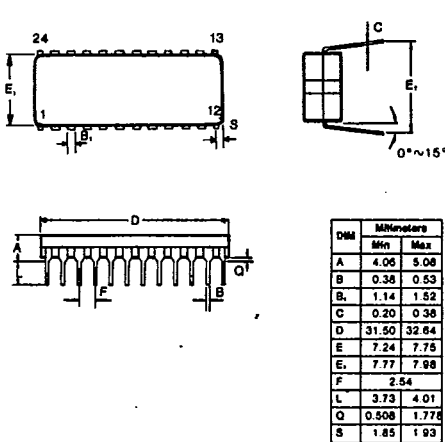
16-Pin Ceramic DIP Units: mm



20-Pin Ceramic DIP Units: mm



24-Pin Ceramic DIP Units: mm



7